



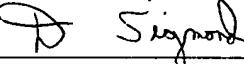
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Cheng-Lien Chiang
Assignee: Bridge Semiconductor Corporation
Title: SEMICONDUCTOR PACKAGE DEVICE
Serial No.: 10/042,812 Filed: January 9, 2002
Examiner: Chu, C. Group Art Unit: 2815
Atty. Docket No.: BDG005

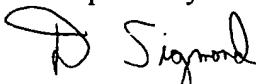
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313

TRANSMITTAL OF FORMAL DRAWINGS

Attached please find the formal drawings (29 sheets) for this application.

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail ER735731194US in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 28, 2004.		
	<u>9/28/04</u>	Date of Signature
David M. Sigmond Attorney for Applicant		

Respectfully submitted,



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